

PC33U62 V0

Product Specification

Approval Sheet

PC33U62 V0

Product Specification

RoHS

Product	White SMD LED
Part Number	PC33U62 V0
Issue Date	2023/03



Feature

- ✓ White SMD LED (L x W x H) of 3.2 x 3.0 x 0.6 mm
- ✓ Hot color targeting ensures that color is within ANSI bin at typical application conditions
- ✓ Enables 3, 4, 5-step MacAdam Ellipse kits
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 3
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 4000 pcs/reel

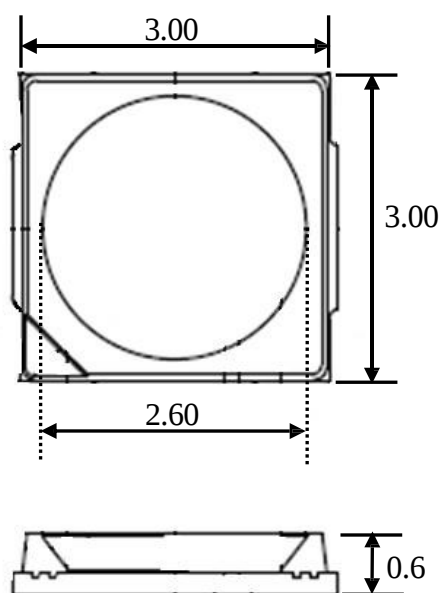
Applications

- ✓ Reading lights
- ✓ Security / garden lighting
- ✓ General lighting
- ✓ Indoor and outdoor commercial lighting

Outline Dimension

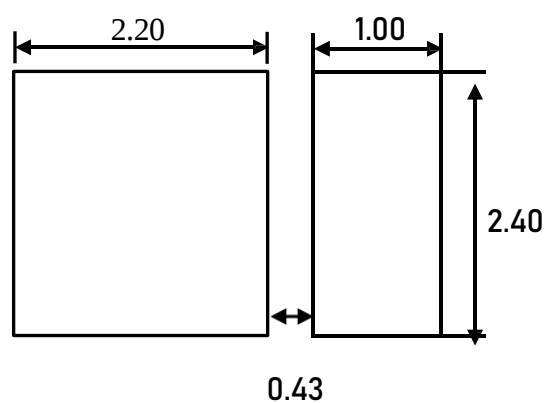
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Unit: mm, Tolerance: $\pm 0.1\text{mm}$

Recommended Soldering Pad



Performance

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■ Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage ⁽¹⁾	V _F	I _F = 65 mA	2.6	2.72	2.9	V
Color Rendering Index ⁽²⁾	Ra		90	-	-	-
View Angle	θ		-	120	-	deg
Thermal Resistance ⁽³⁾	R _{th}		-	6	-	°C/W

(1) The Forward Voltage tolerance is ±0.1V

(2) The Color Rendering Index is measured at Ta=85°C and tolerance is ±2

(3) Thermal resistance is calculated from junction to solder

■ Luminous Flux (Ta=25°C)

CCT	Condition	Rank	Typ.	Unit
2700K~3700K	I _F = 65 mA	G1 G2 H1	29.4	lm
3700K~7000K		G2 H1 H2	31.2	

* The luminous flux tolerance is ± 7%

■ Absolute Maximum Ratings

Parameter	Symbol	value	Unit
DC Forward Current ⁽¹⁾	I _F	400	mA
Power Dissipation	P _D	0.96	W
Pulse Forward Current ⁽²⁾	I _{FP}	400	mA
Storage Temperature	T _{stg}	-40 ~ 100	°C
Operating Temperature	T _{opr}	-40 ~ 100	°C
Junction Temperature	T _J	125	°C
Assembly Temperature	-	260 (max. 10sec)	°C

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP Condition: Duty 1/10, Pulse within 10msec

Ordering Code

P C 3 3 U 6 2 0 - A 2 7 1 B 0 G 1 H 1 8 0 - 0 0 0

1	2	3	4	5	6	7	8		9	10	11	12	13	14	15	16	17	18	19	20		21	22	23
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Item	Pos.	Code	Spec
Model Name	1-8	PC33U620	PC33U62 V0
CIE Center Point	9	A	ANSI 1931 on B.B.L
CCT	10,11	27	27 = 2700K
		30	30 = 3000K
		35	35 = 3500K
		40	40 = 4000K
		50	50 = 5000K
		57	57 = 5700K
		65	65 = 6500K
Ra	12	1	Ra >90
CIE Bin Group ⁽¹⁾	13,14	A0 B0	27A 27A,27B,27C,27D,27E
IV Bin Group	15,16, 17,18	G1H1	Bin code :G1 H1 H2
Vf Bin Group	19,20	80	Bin code : 8,9,0
Kittin g Rules	CIE ⁽¹⁾	21	0 1 ⁽²⁾ 2 ⁽²⁾
			No requirements. 27A+27A,27B+27D,27C+27E 27A+27A,27B+27D,27C+27E 27F+27H,27G+27I
	IV	22	0
	Vf	23	0

- (1) The first two digits 27 means CCT in 2700K, can be replaced to 30, 35, 40, 50, 57, 65 for different CCT requirements.
- (2) Only under an agreement between customer and Lextar Electronics, kitting rules besides "0" can be supplied.

■ **Standard Ordering Code:**

CCT	Ordering Code ⁽¹⁾	CIE Bin Group	IV Bin Group	Vf Bin Group
2700K	PC33U620-A271A0G1H180-000	A0	G1 H1 H2	8,9,0
	PC33U620-A271B0G1H180-000	B0		
3000K	PC33U620-A301A0G1H180-000	A0	G1 H1 H2	8,9,0
	PC33U620-A301B0G1H180-000	B0		
3500K	PC33U620-A351A0G1H180-000	A0	G1 H1 H2	8,9,0
	PC33U620-A351B0G1H180-000	B0		
4000K	PC33U620-A401A0G2H280-000	A0	G2 H1 H2	8,9,0
	PC33U620-A401B0G2H280-000	B0		
5000K	PC33U620-A501A0G2H280-000	A0	G2 H1 H2	8,9,0
	PC33U620-A501B0G2H280-000	B0		
5700K	PC33U620-A571A0G2H280-000	A0	G2 H1 H2	8,9,0
	PC33U620-A571B0G2H280-000	B0		
6500K	PC33U620-A651A0G2H280-000	A0	G2 H1 H2	8,9,0
	PC33U620-A651B0G2H280-000	B0		

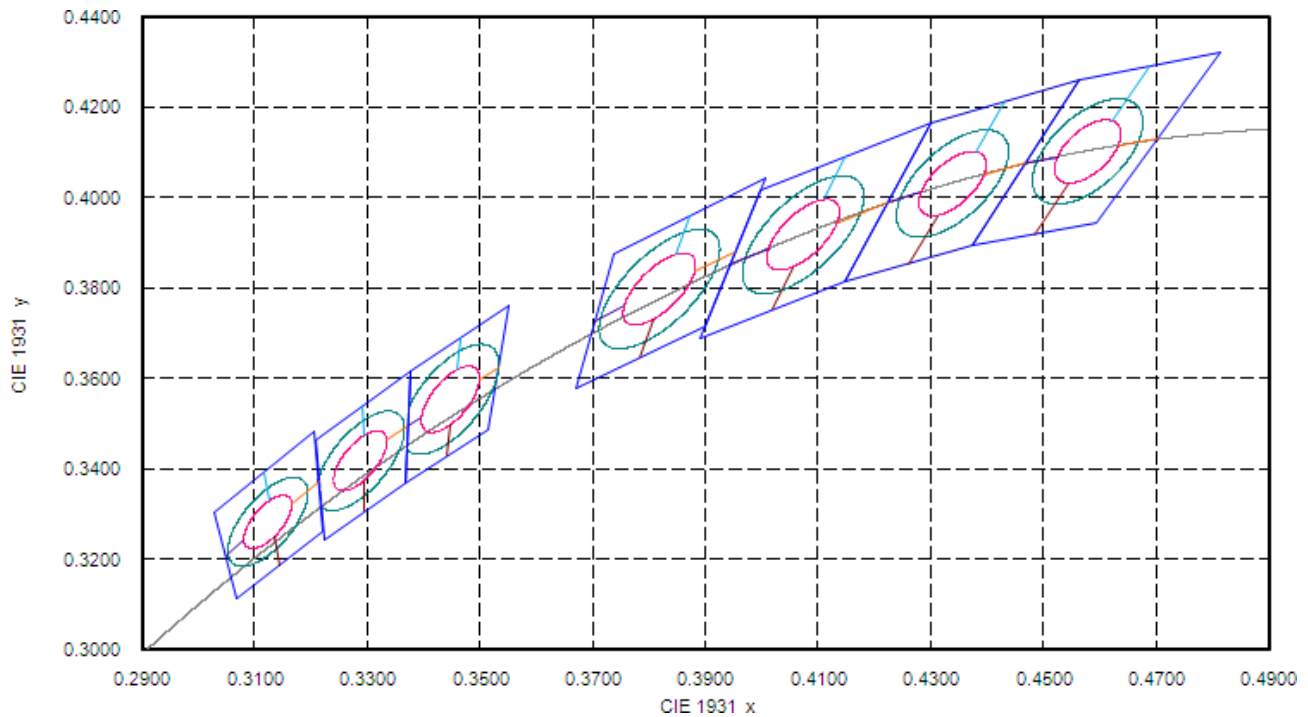
(1) Only under an agreement between customer and Lextar Electronics, Ordering codes not in "Standard Ordering Code Definitions" can be supplied.

Binning

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Chromaticity Coordinates



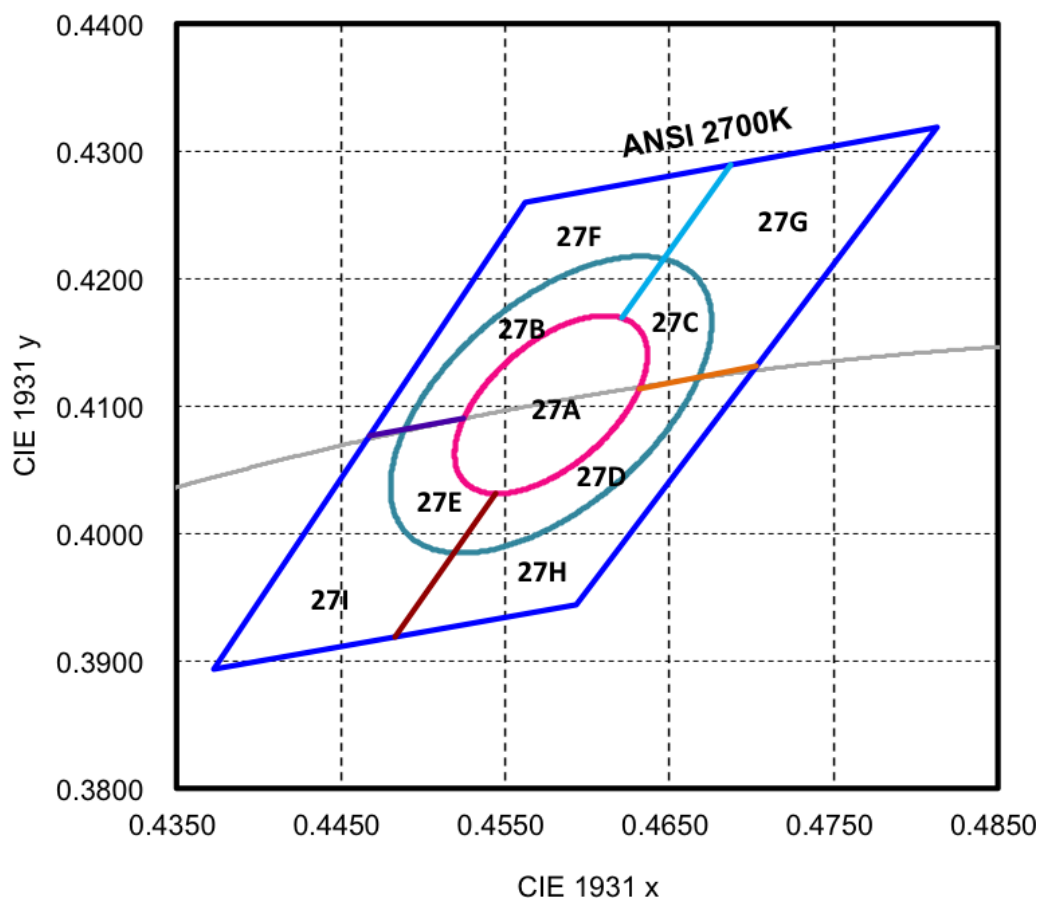
Bin code definition

V _F Rank	Luminous Flux Rank	CIE Rank
8	H1	A27

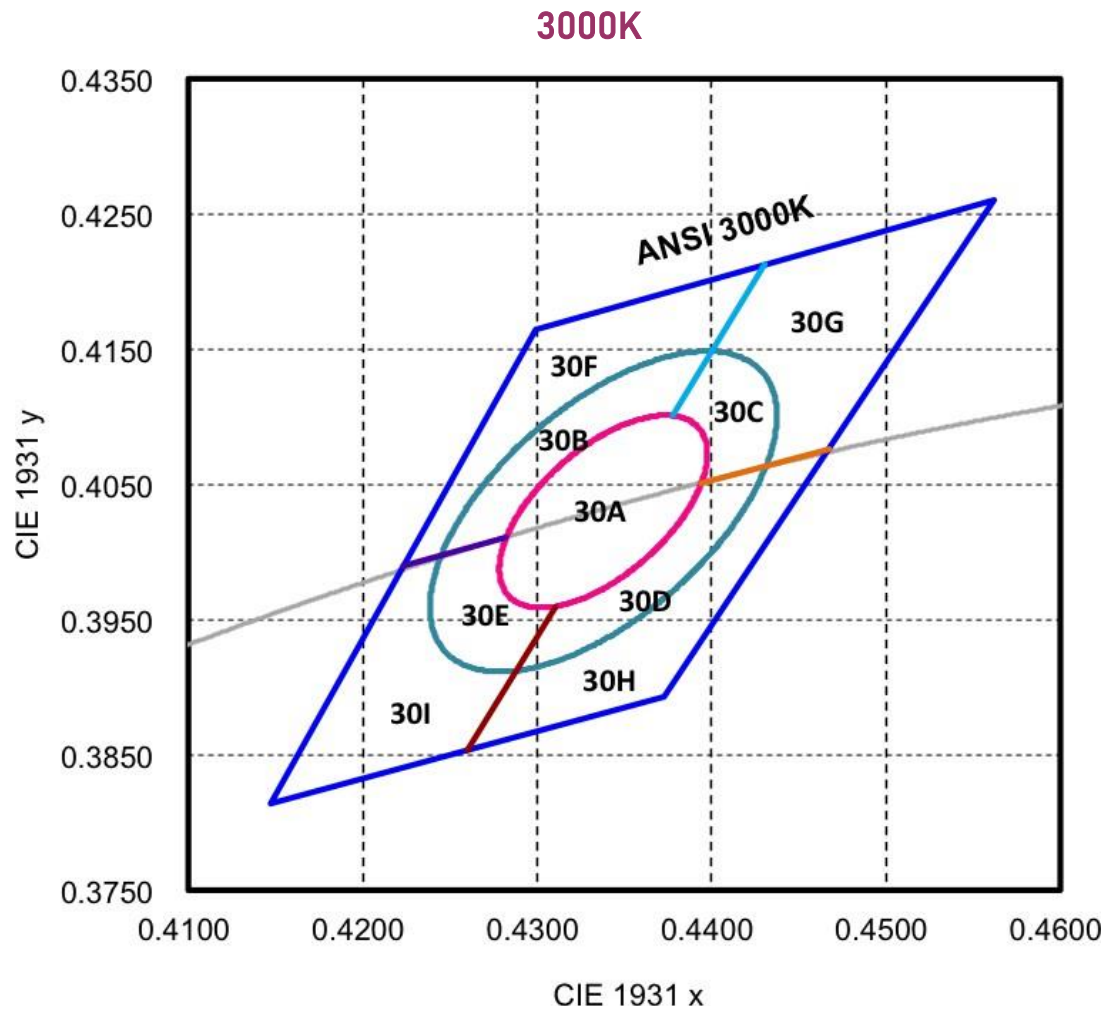
V _F Rank	Condition	Min.	Max.
8	I _F = 65 mA T _j =25°C	2.6	2.7
9		2.7	2.8
0		2.8	2.9

Luminous Flux Rank	Condition	Min.	Max.
F2	I _F = 65 mA T _j =25°C	25.5	27.5
G1		27.5	29.5
G2		29.5	31.5
H1		31.5	33.5
H2		33.5	35.5

2700K

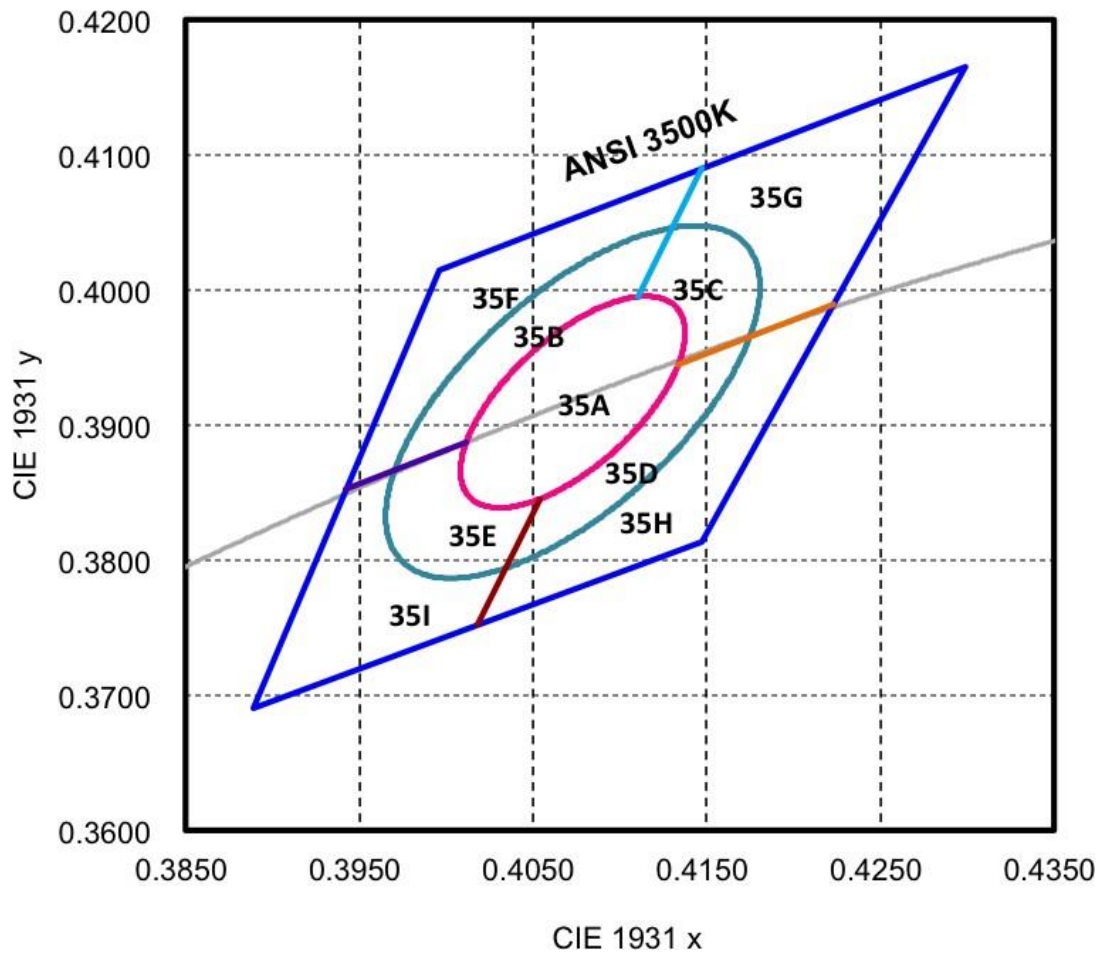


Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
2700K	Single 3-step MacAdam ellipse	(0.4578, 0.4101)	0.00810	0.00420	53.70°
2700K	Single 5-step MacAdam ellipse	(0.4578, 0.4101)	0.01350	0.00700	53.70°

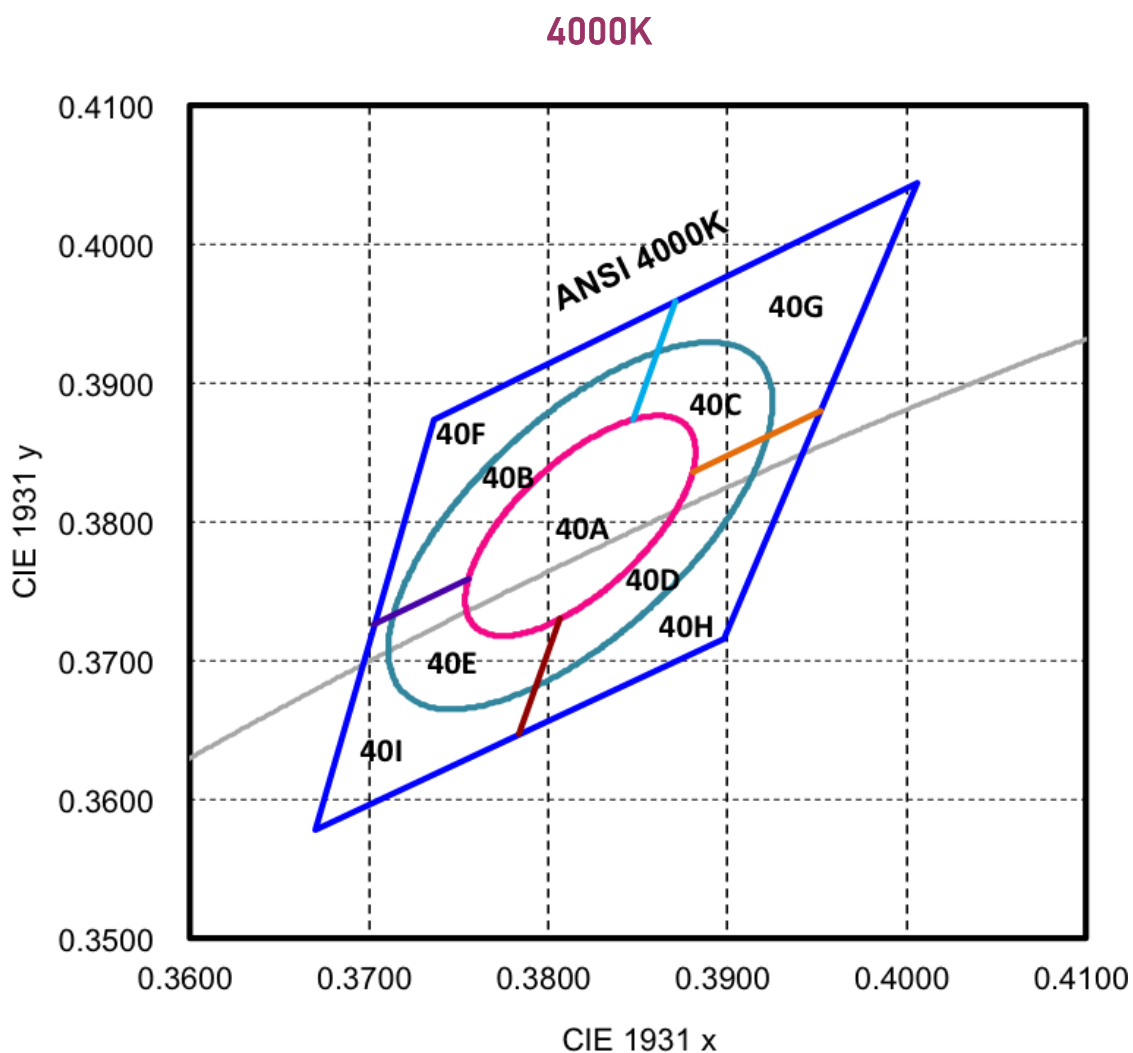


Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
3000K	Single 3-step MacAdam ellipse	(0.4338, 0.403)	0.00834	0.00408	53.22°
3000K	Single 5-step MacAdam ellipse	(0.4338, 0.403)	0.01390	0.00680	53.22°

3500K

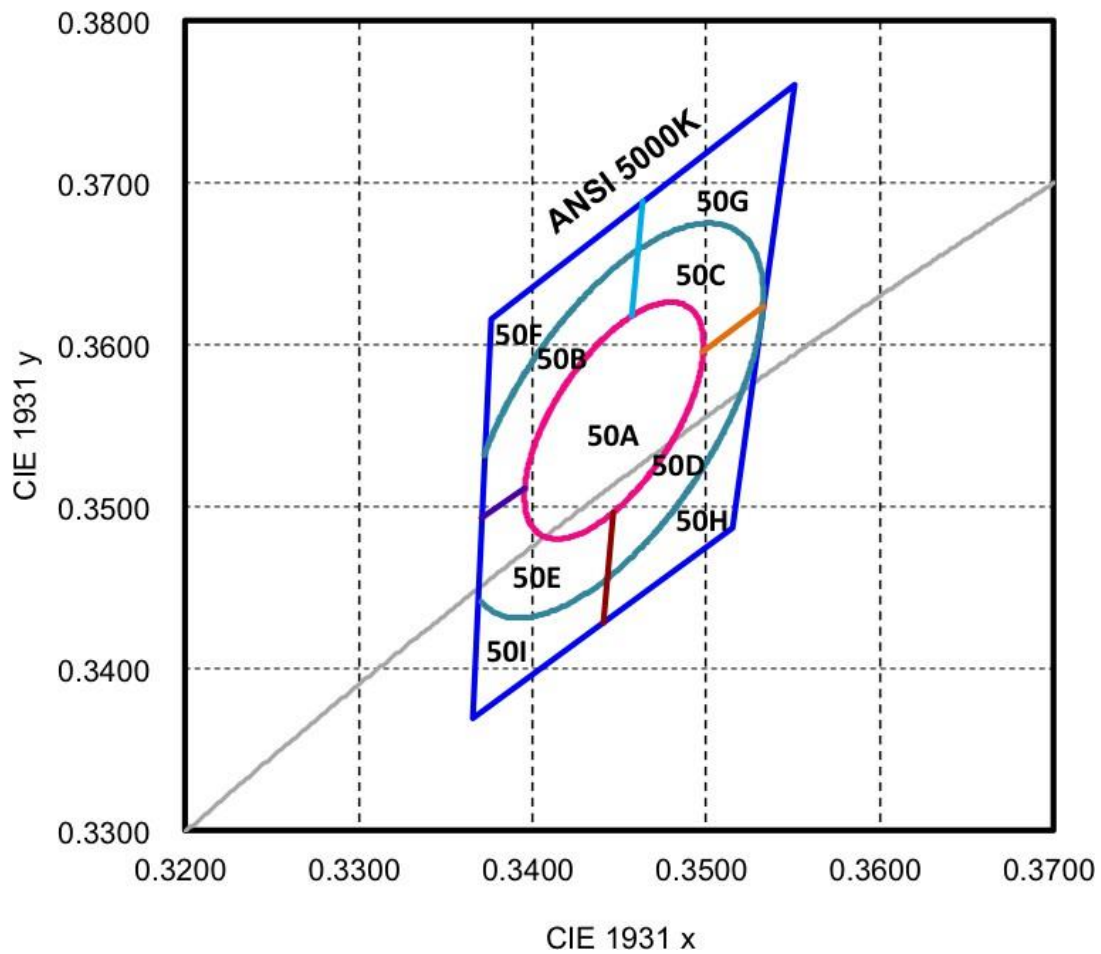


Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
3500K	Single 3-step MacAdam ellipse	(0.4073, 0.3917)	0.00927	0.00414	53.22°
3500K	Single 5-step MacAdam ellipse	(0.4073, 0.3917)	0.01545	0.00690	53.22°



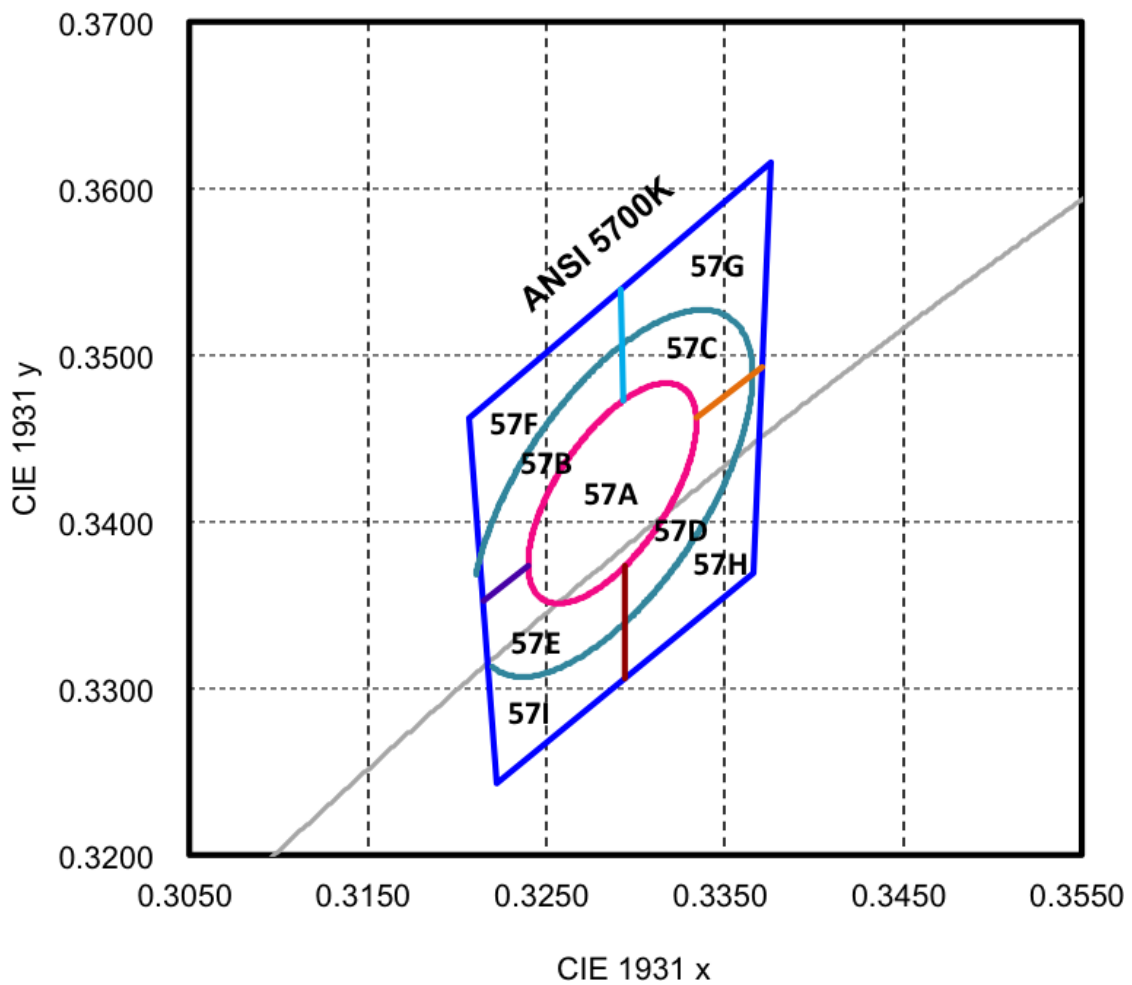
Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
4000K	Single 3-step MacAdam ellipse	(0.3818, 0.3797)	0.00939	0.00402	53.72°
4000K	Single 5-step MacAdam ellipse	(0.3818, 0.3797)	0.01565	0.00670	53.72°

5000K



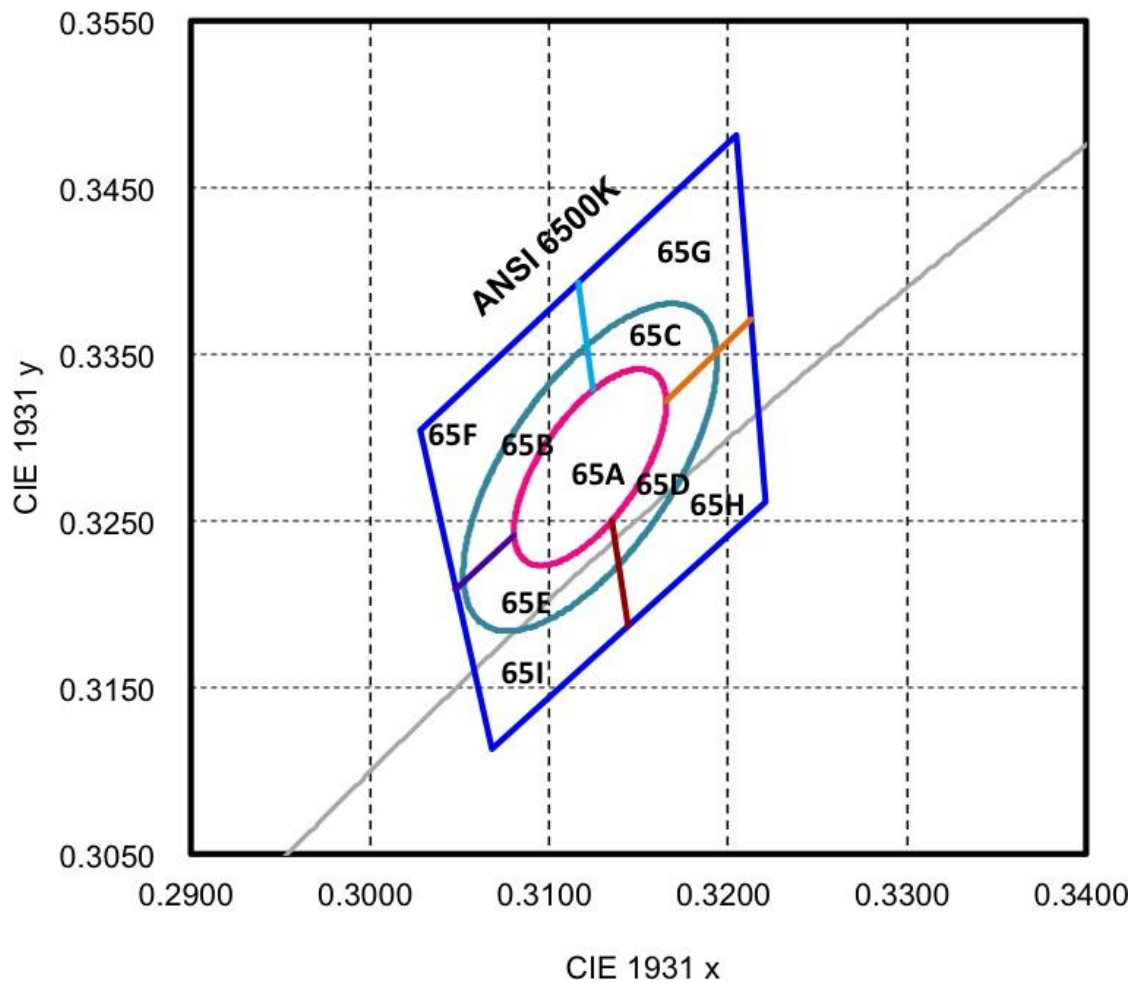
Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
5000K	Single 3-step MacAdam ellipse	(0.3447, 0.3553)	0.00822	0.00354	59.62°
5000K	Single 5-step MacAdam ellipse	(0.3447, 0.3553)	0.01370	0.00590	59.62°

5700K



Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
5700K	Single 3-step MacAdam ellipse	(0.3287, 0.3417)	0.00746	0.00320	59.09°
5700K	Single 5-step MacAdam ellipse	(0.3287, 0.3417)	0.01243	0.00533	59.09°

6500K



Nominal ANSI CCT	Color Space	Target Center Point (cx, cy)	Major Axis, a	Minor Axis, b	Ellipse Rotation Angle
6500K	Single 3-step MacAdam ellipse	(0.3123, 0.3282)	0.00669	0.00285	58.57°
6500K	Single 5-step MacAdam ellipse	(0.3123, 0.3282)	0.01115	0.00475	58.57°

Note:

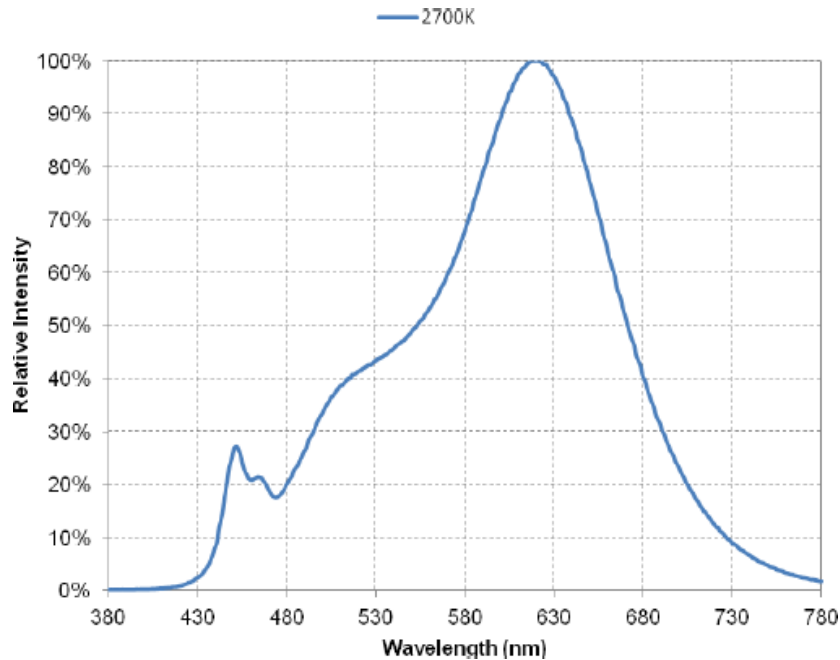
- (1) Correlated color temperature is derived from the CIE 1931 chromaticity diagram.
- (2) CIE measurement tolerance is ± 0.005
- (3) The luminous flux tolerance is $\pm 7\%$
- (4) The forward voltage tolerance is $\pm 0.1V$

Characteristic

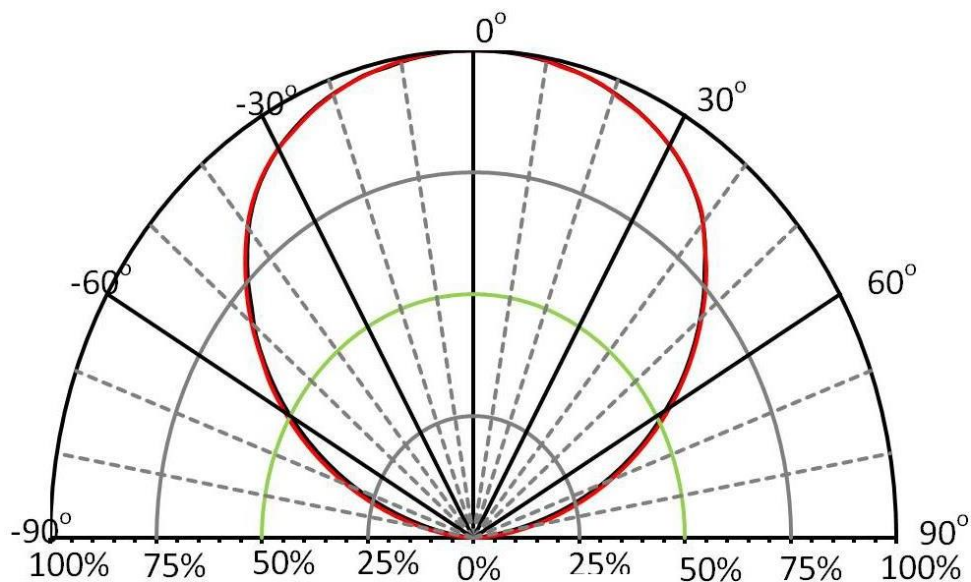
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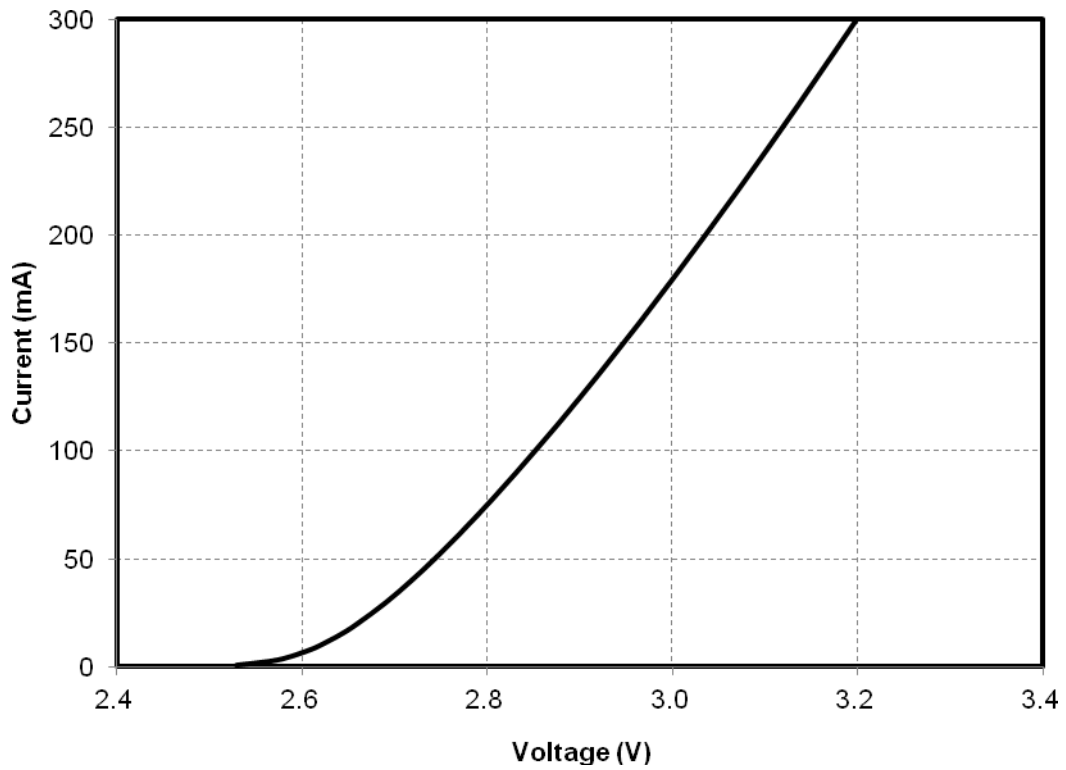
Spectrum



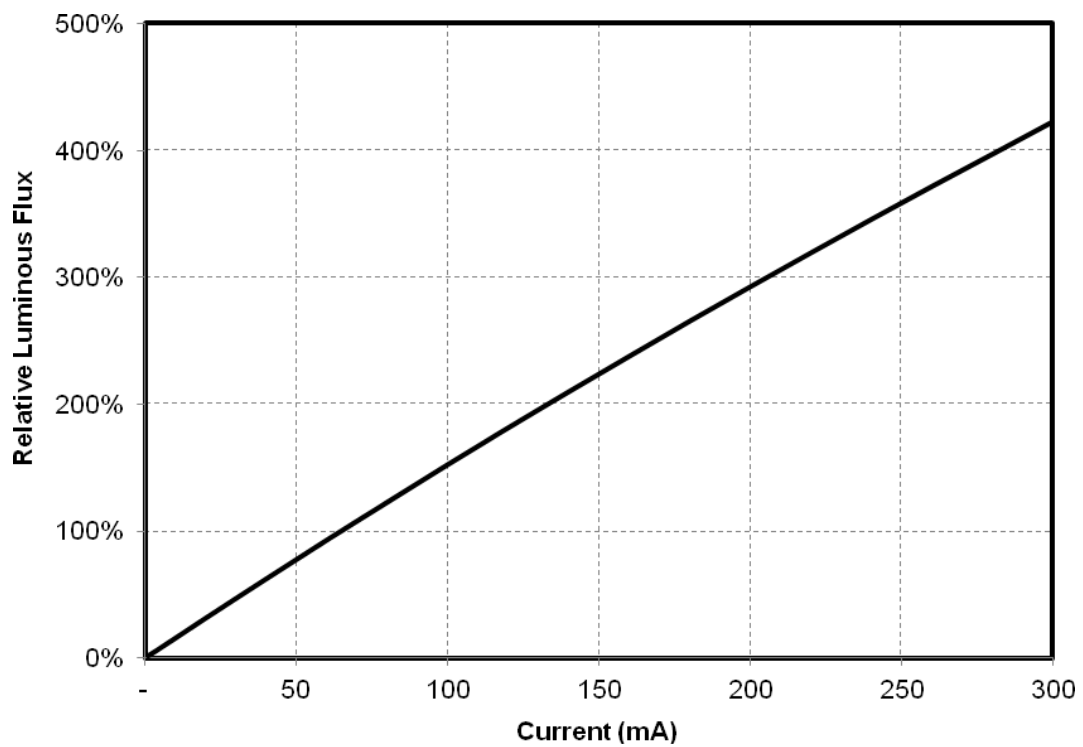
Radiation Pattern



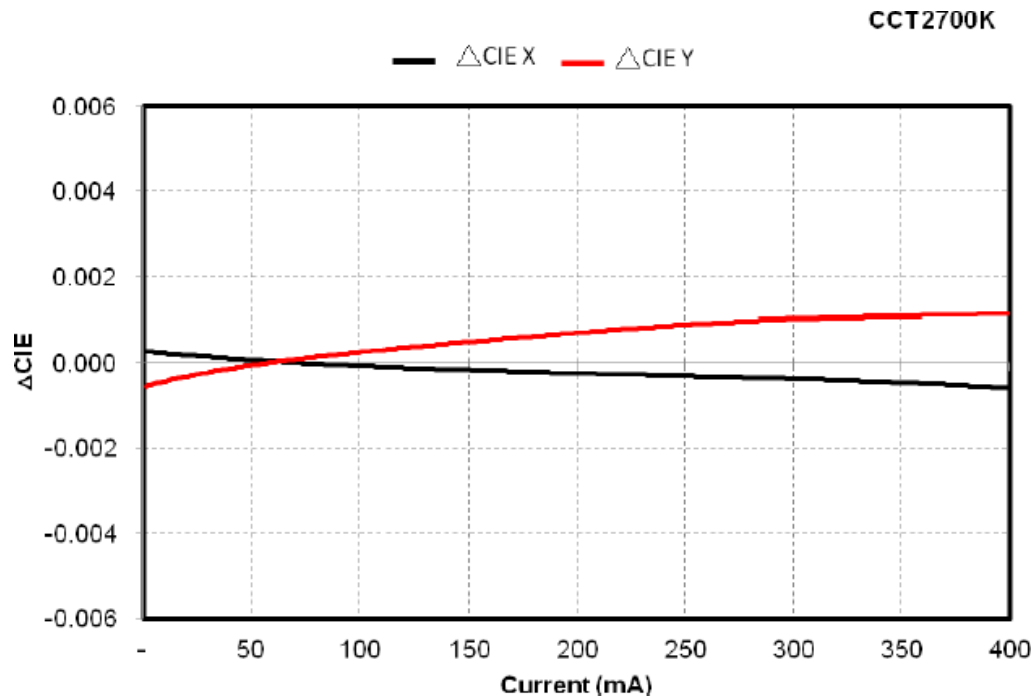
■ Forward Voltage vs. Forward Current



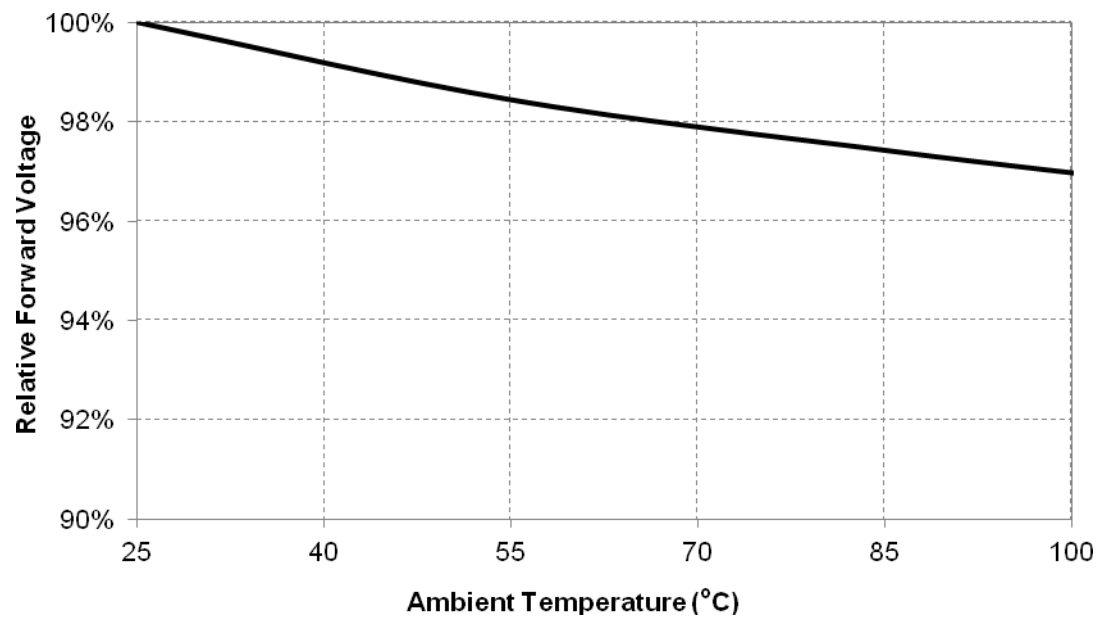
■ Forward Current vs. Relative Luminosity



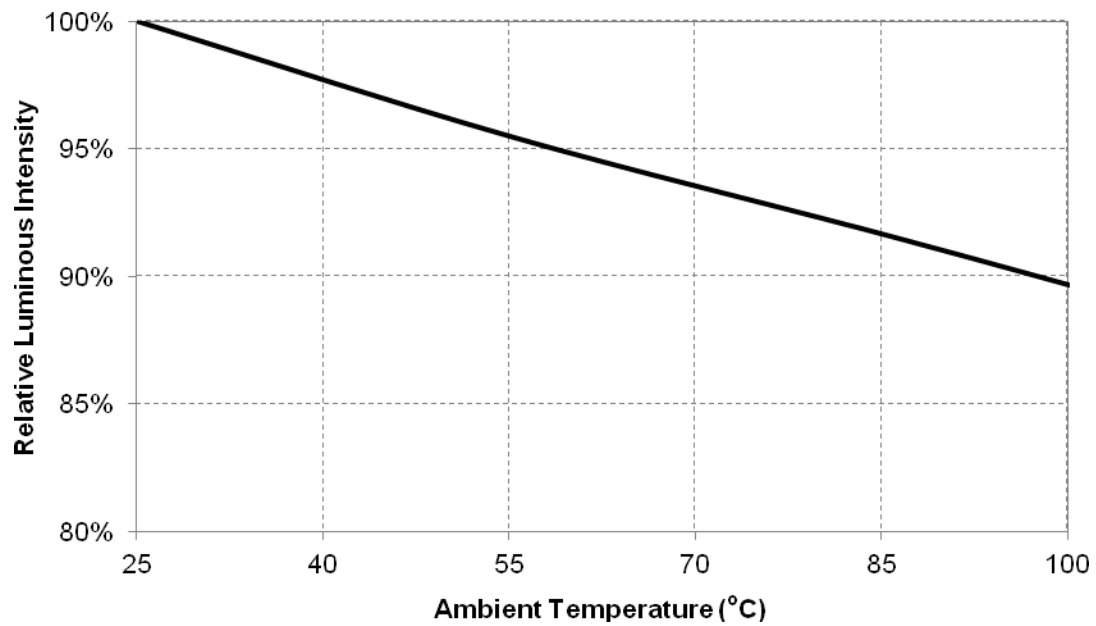
■ Forward Current vs. Chromaticity Coordinate



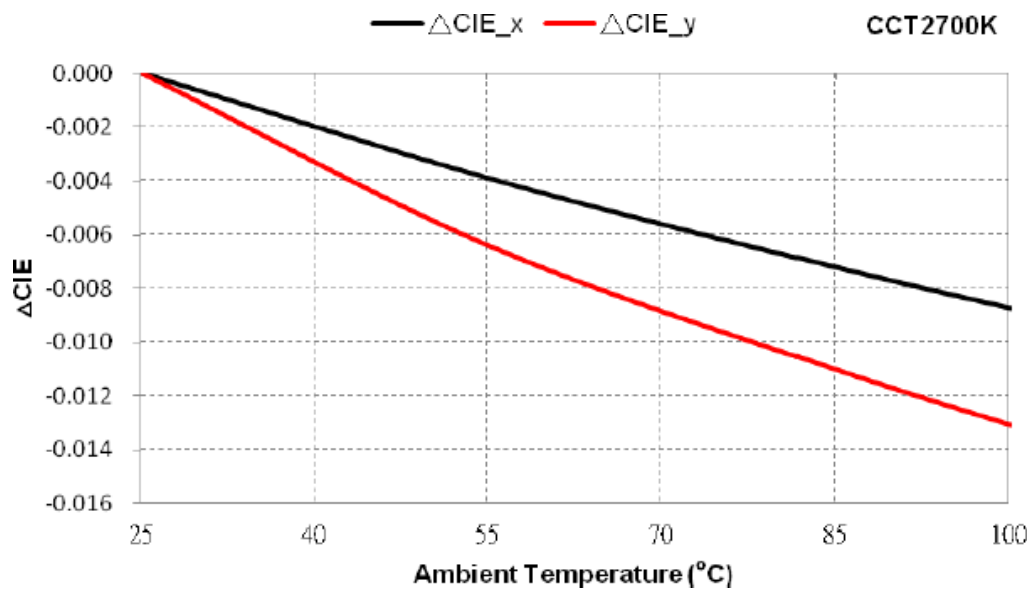
■ Relative Forward Voltage vs. Ambient Temperature



■ Relative Luminous Intensity vs. Ambient Temperature



■ Chromaticity vs. Ambient Temperature



Reliability

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Reliability test

Item	Condition	Current	Time/Cycle
Steady State Operating Life of Low Temperature -40℃	-40℃ Operating	300mA	1000 Hrs
Steady State Operating Life of High Temperature 60℃	60℃ Operating	300mA	1000 Hrs
Steady State Operating Life of High Temperature 85℃	85℃ Operating	300mA	1000 Hrs
Steady State Operating Life of High Temperature 100℃	105℃ Operating	300mA	1000 Hrs
Low temperature storage -40℃	-40℃ Storage	NA	1000 Hrs
High temperature storage 100℃	100℃ Storage	NA	1000 Hrs
Steady State Operating Life of High Humidity Heat 60℃ 90%	60℃/90% Operating	300mA	1000 Hrs
Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60℃, 60%RH for 52hrs Tslid max.=260℃ 10sec	NA	3 Times
Thermal shock	-40℃/20minr ~5minr ~ 100℃/20min	NA	300 Cycles

Judgment Criteria

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	65mA	$\Delta V_f < 10 \%$
Luminous Flux	Iv	65mA	$\Delta I_v < 30 \%$

Packing

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Label

Lextar



QTY :



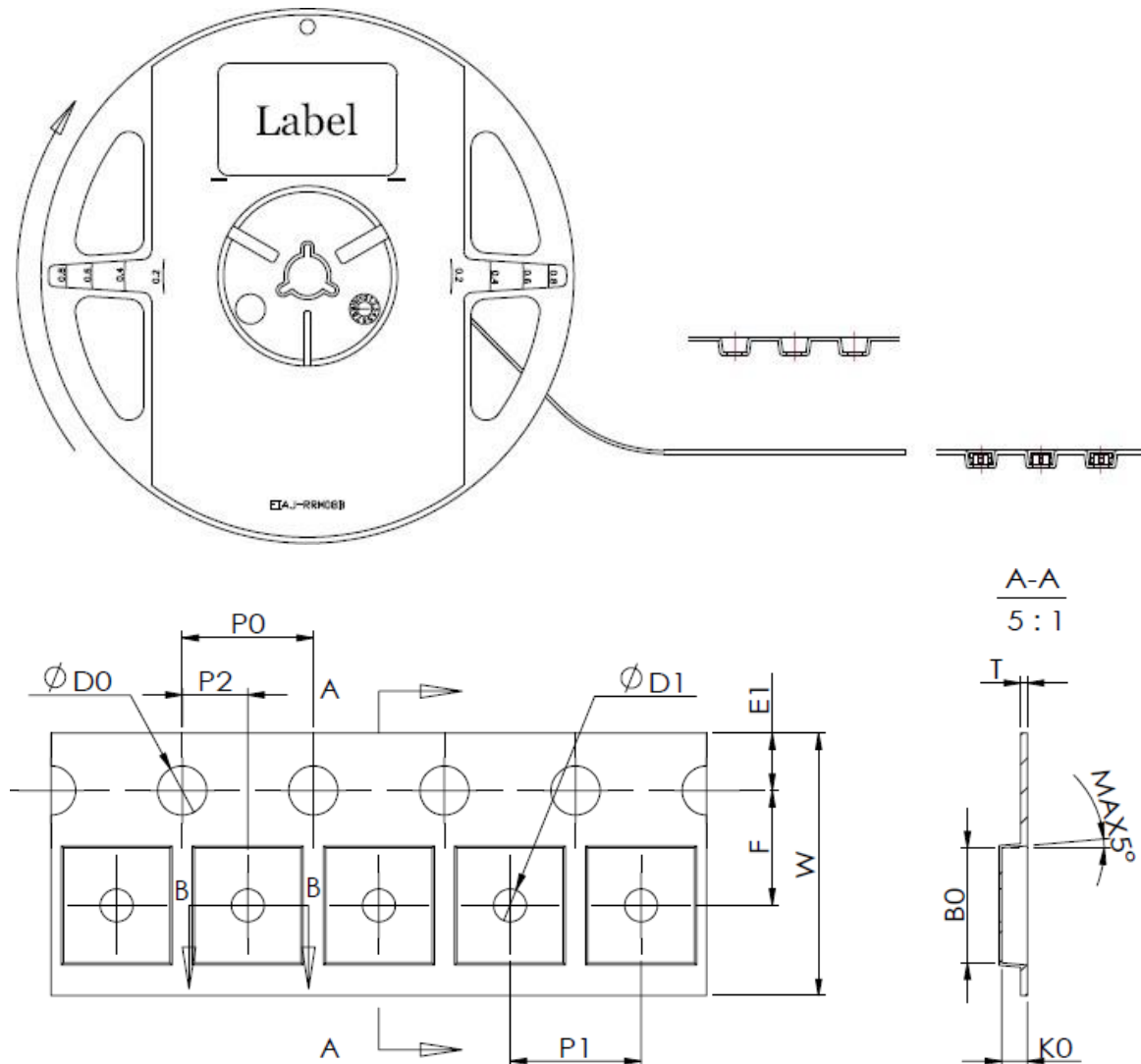
Bin code :

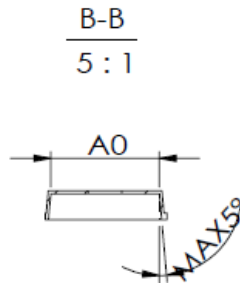


Vendor lot :

M/N :

Carrier Taping



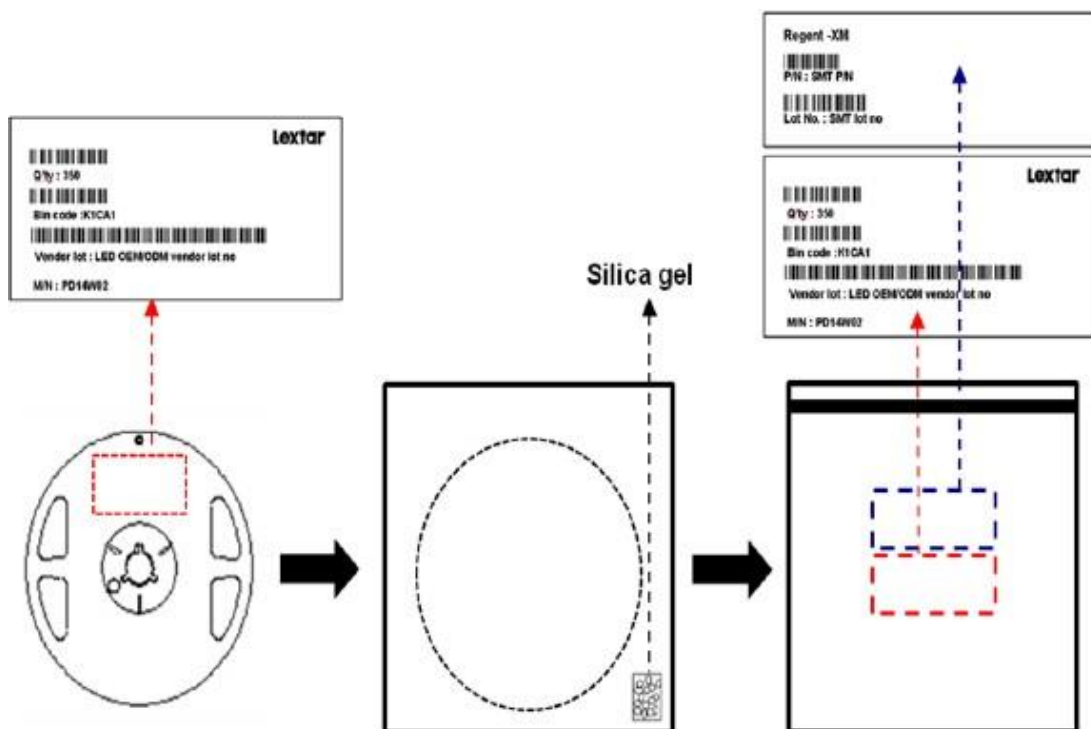


W	P1	E1	F	D0	D1
8.0	4.0	1.75	3.5	1.5	1.0
P0	P2	A0	B0	K0	T
4.0	2.0	3.25	3.5	0.8	0.22

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is $\pm 0.20\text{mm}$.
2. Carrier camber shall be not more than 1mm per 100mm through a length of 250mm.
3. Ao & Bo measured on a place in the middle of the corner radii.
4. Ko measured from a place on the inside bottom of the pocket to top surface of carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Surface resistivity $10^4 \sim 10^8$ ohm/sq.

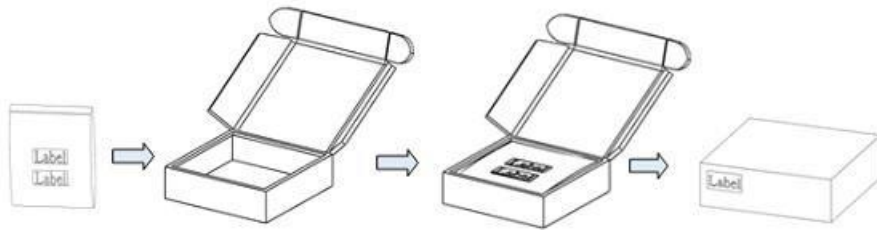
Shield Bag Taping



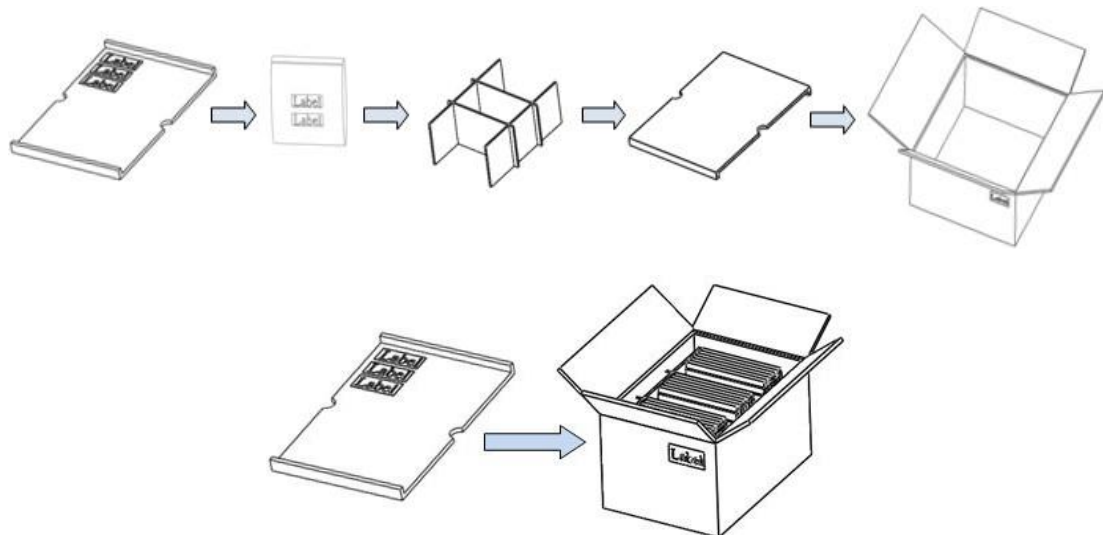
Packing Box

Type	Large Box		Medium Box		Small Box	
Dimension	541X511X276mm		385X303X260mm		283X235x70mm	
Maximum Reels	7"X8mm Reel	80/R	7"X8m Reel	30/R	7"X8mm Reel	5/R
Minimum Reels	7"X8mm Reel	41/R	7"X8mm Reel	11/R	7"X8mm Reel	1/R

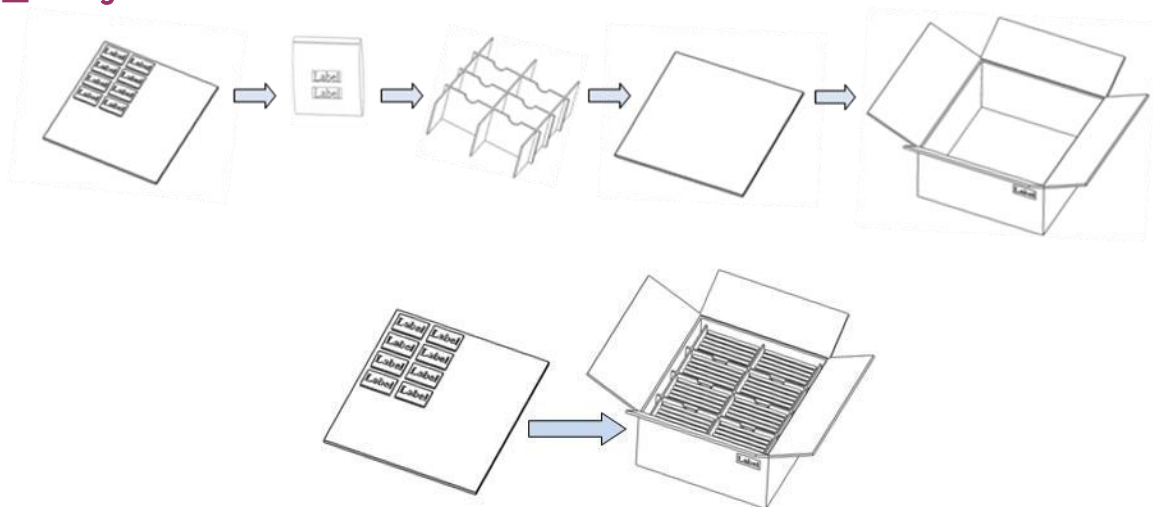
Small Box



Medium Box



Large Box



Precautions

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■ Safety Precautions

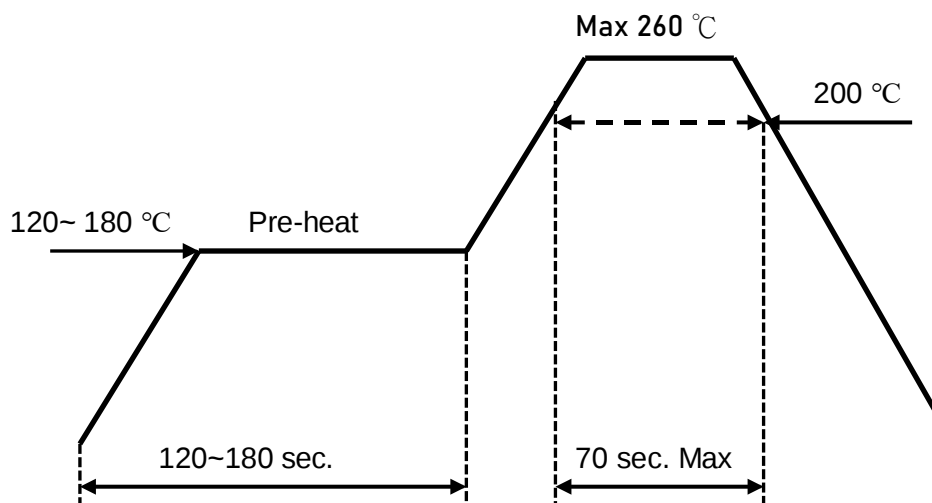
- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

■ Storage

- Before opening the package, the LEDs should storage under 30°C, 60% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 60% RH. Recommend to use within 168 hrs. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel. Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.
Bake condition: 60°C, 12hours (One time only).

■ Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
Hand soldering: 350 °C max, 3 sec. max.
Reflow soldering: Pre-heat 150 °C max, 180 sec. max.
Peak 260 °C max, 10 sec. max.
- Reflow temperature profile as below: (lead-free solder)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

■ Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

■ Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.

Date	Contents	Writer	Approved
2018.11.16	New Version	Bug Huang	Ching Chen
2019.03.18	Revise Performance	Bug Huang	Ching Chen
2019.04.30	Update characteristics	Bug Huang	Ching Chen
2023.03	Update recommended soldering pad & packing quantity	Lily Dai	Ching Chen